

Fig. 1

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TC 2800 MAIL ROOM



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1C 2800 MAIL ROOM

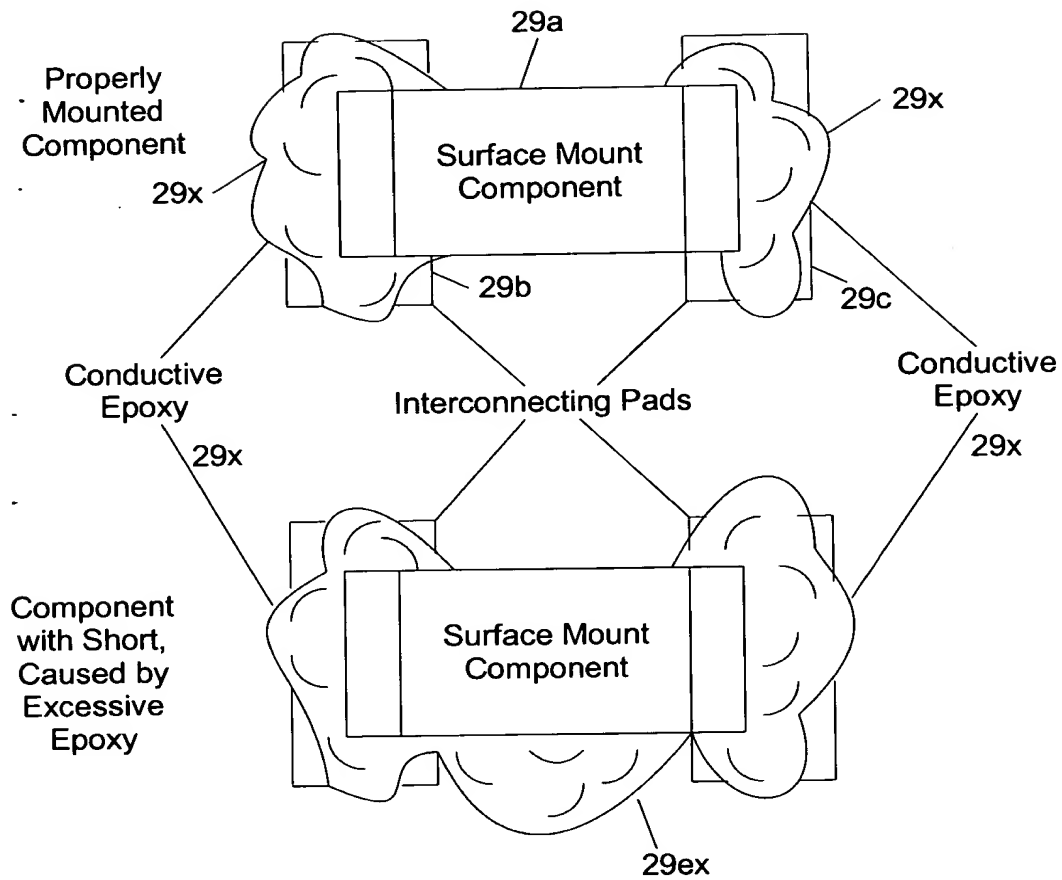
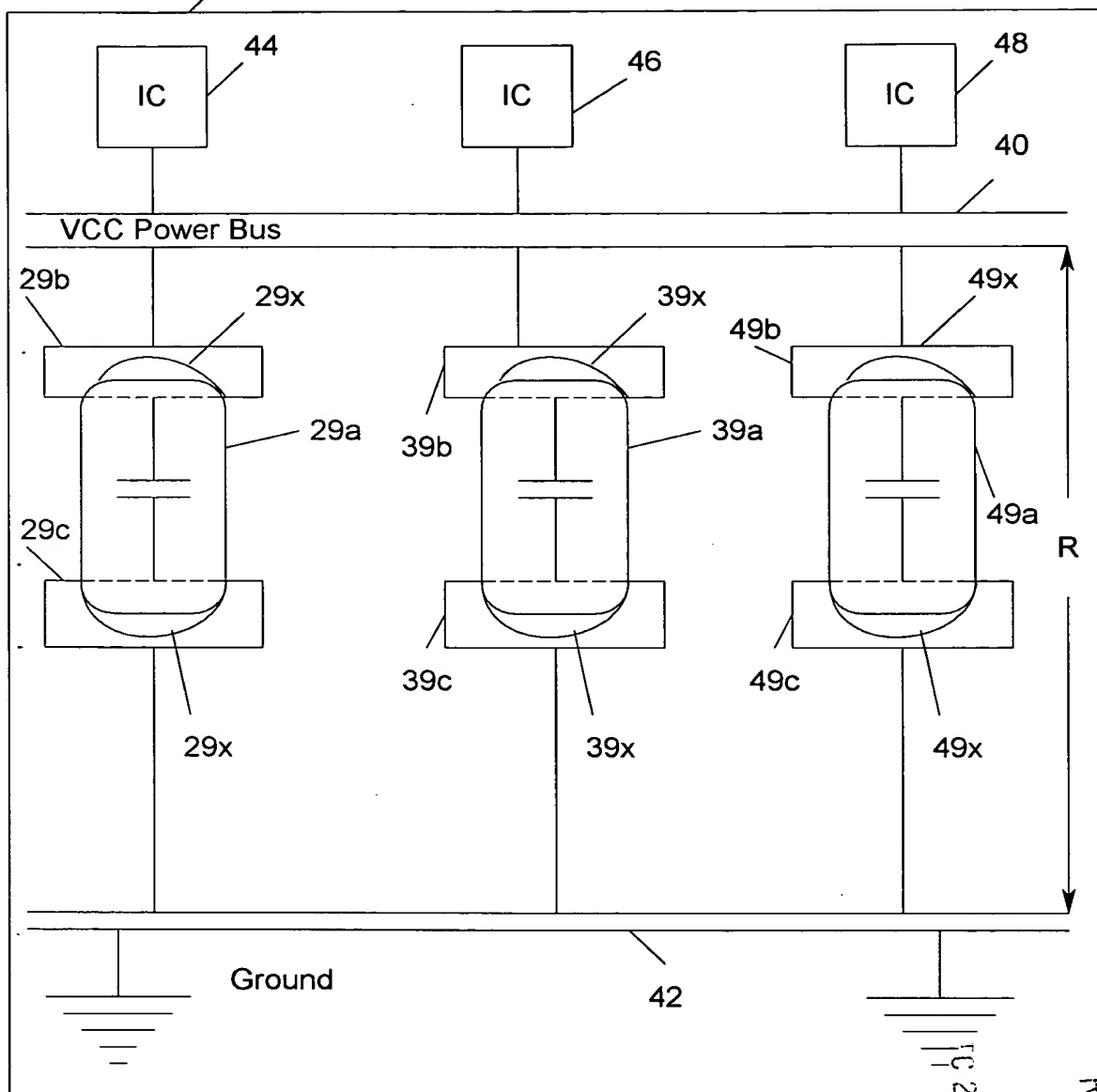


Fig. 2A



Multichip Ceramic Package 28



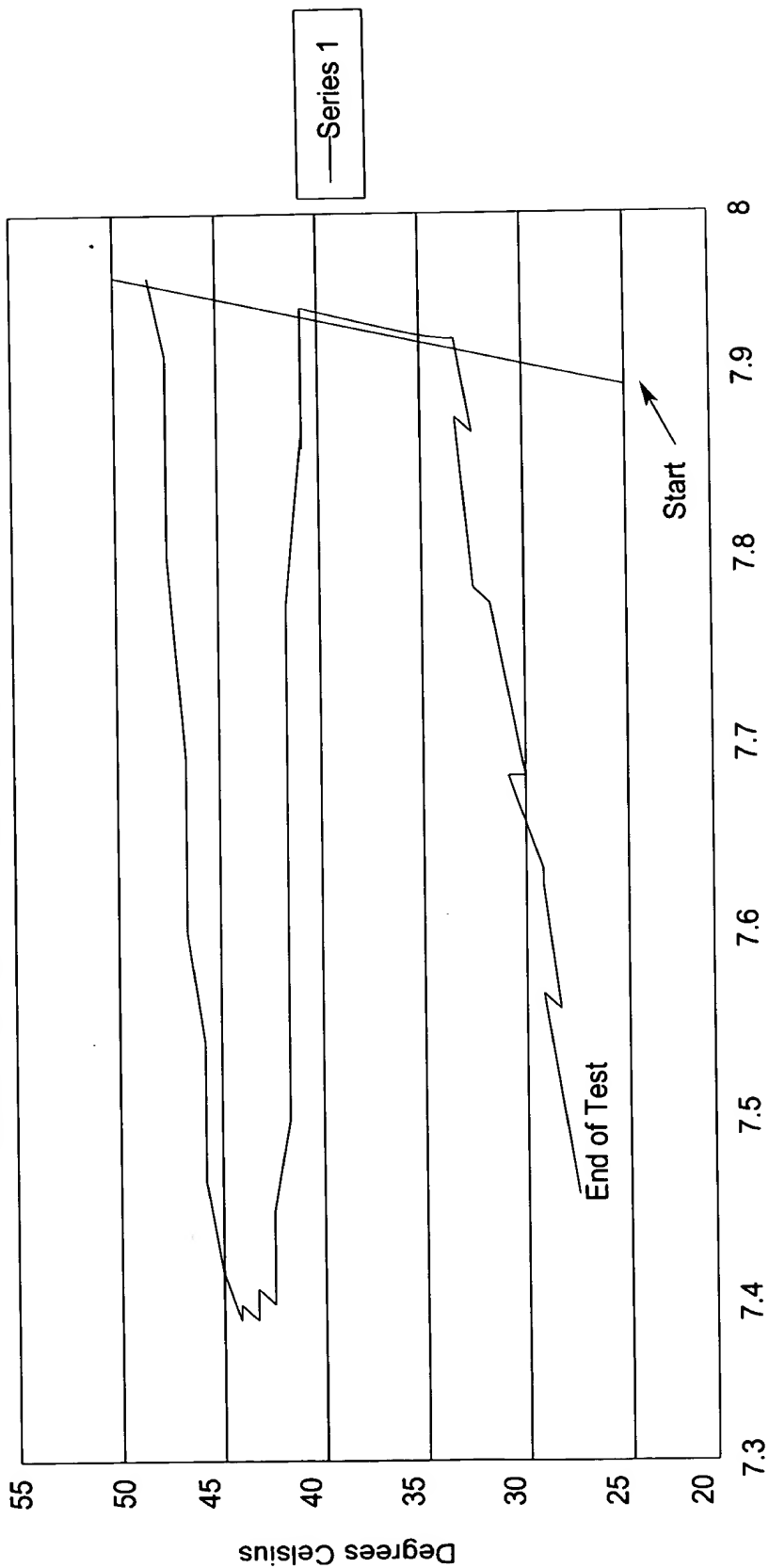
R =
measured
resistance
during temperature
ramp-up and ramp-down

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Fig. 2B



Defective Part with Intermittent Short (W1008)

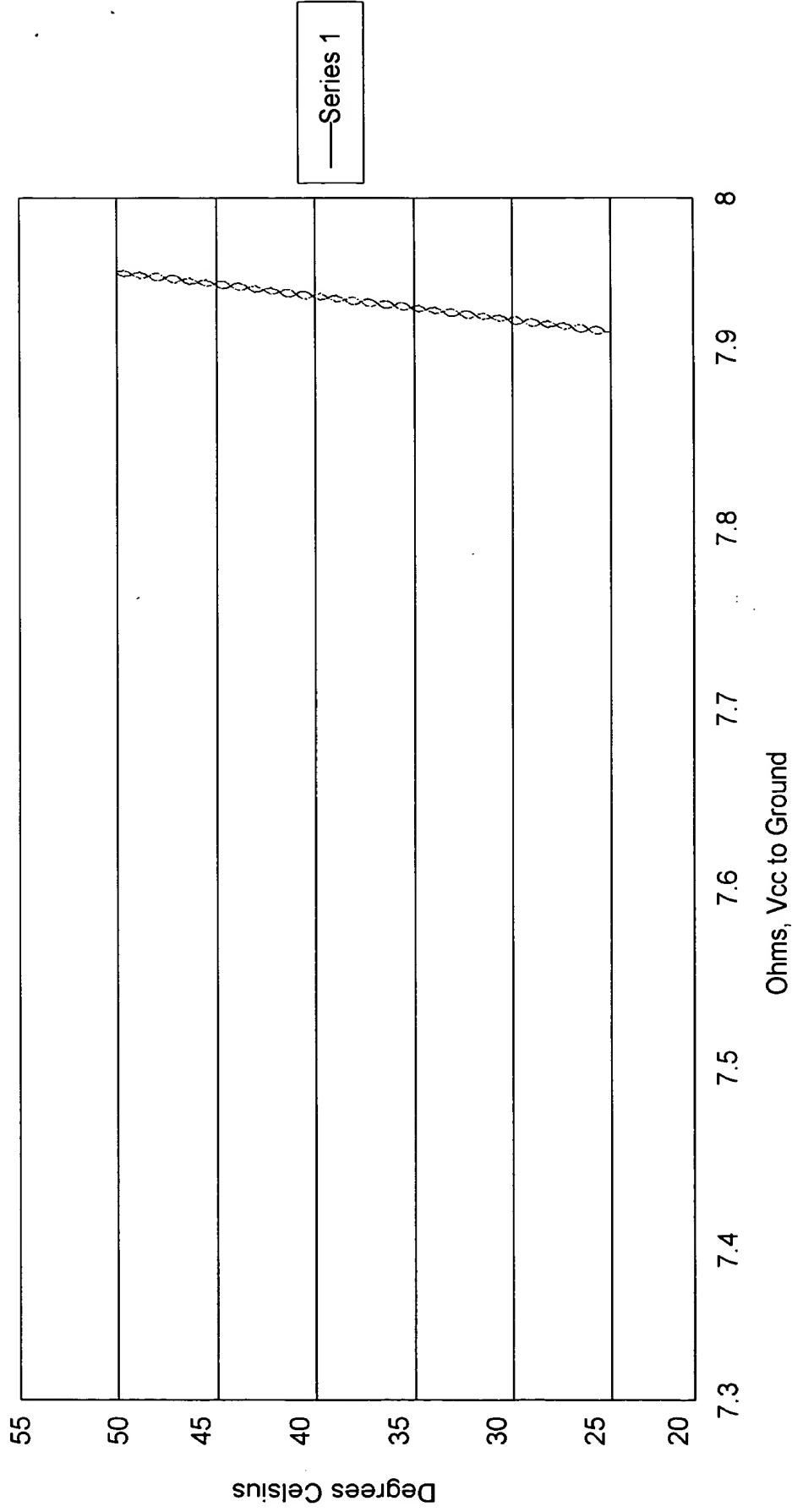


Ohms, Vcc to Ground

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Fig. 3A

Part W1008 After Removal of Short



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Fig. 3B



Defective Epoxy Contact on Part (W1020)

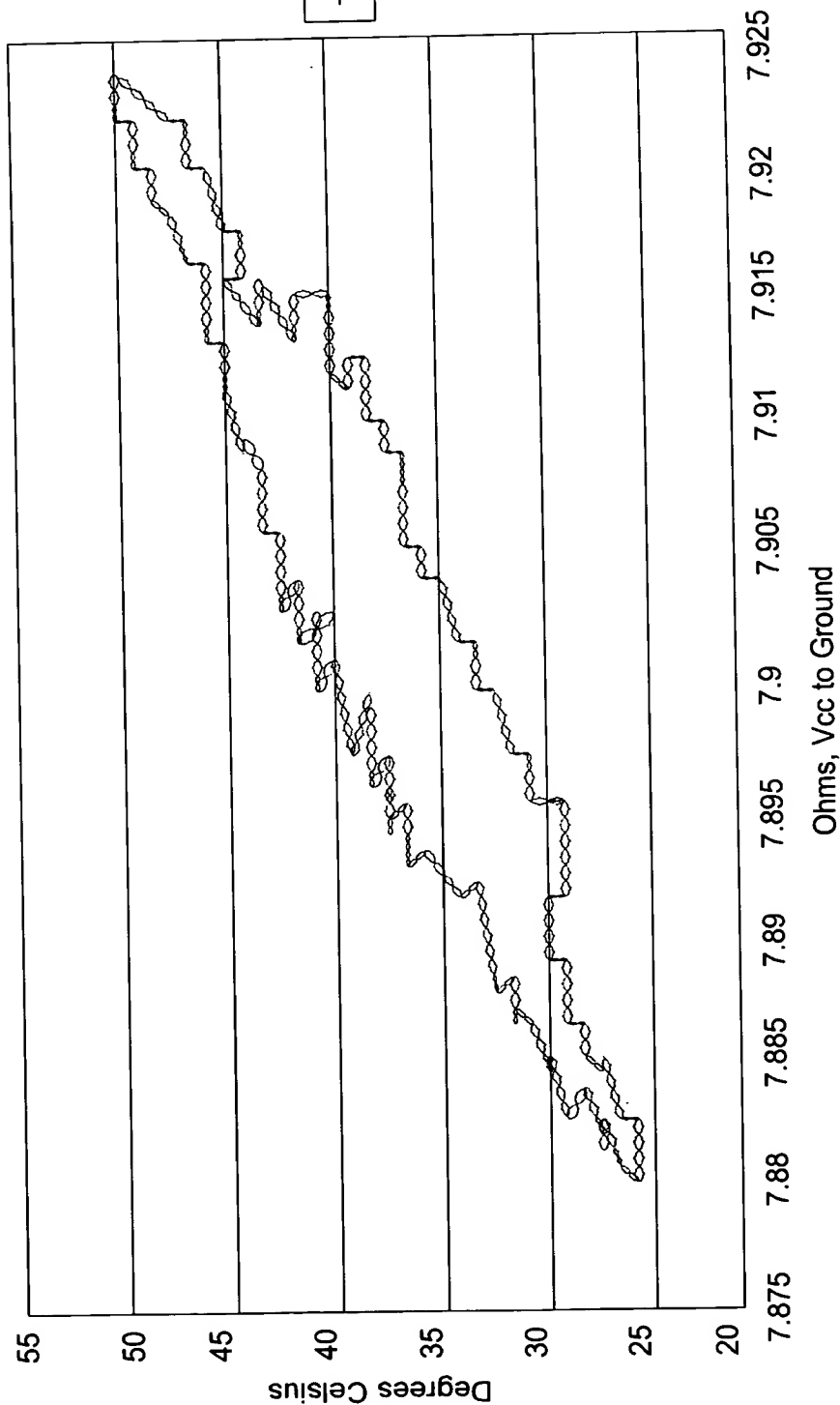


Fig. 4

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Part W1020 After Repair of Defective Epoxy Contact

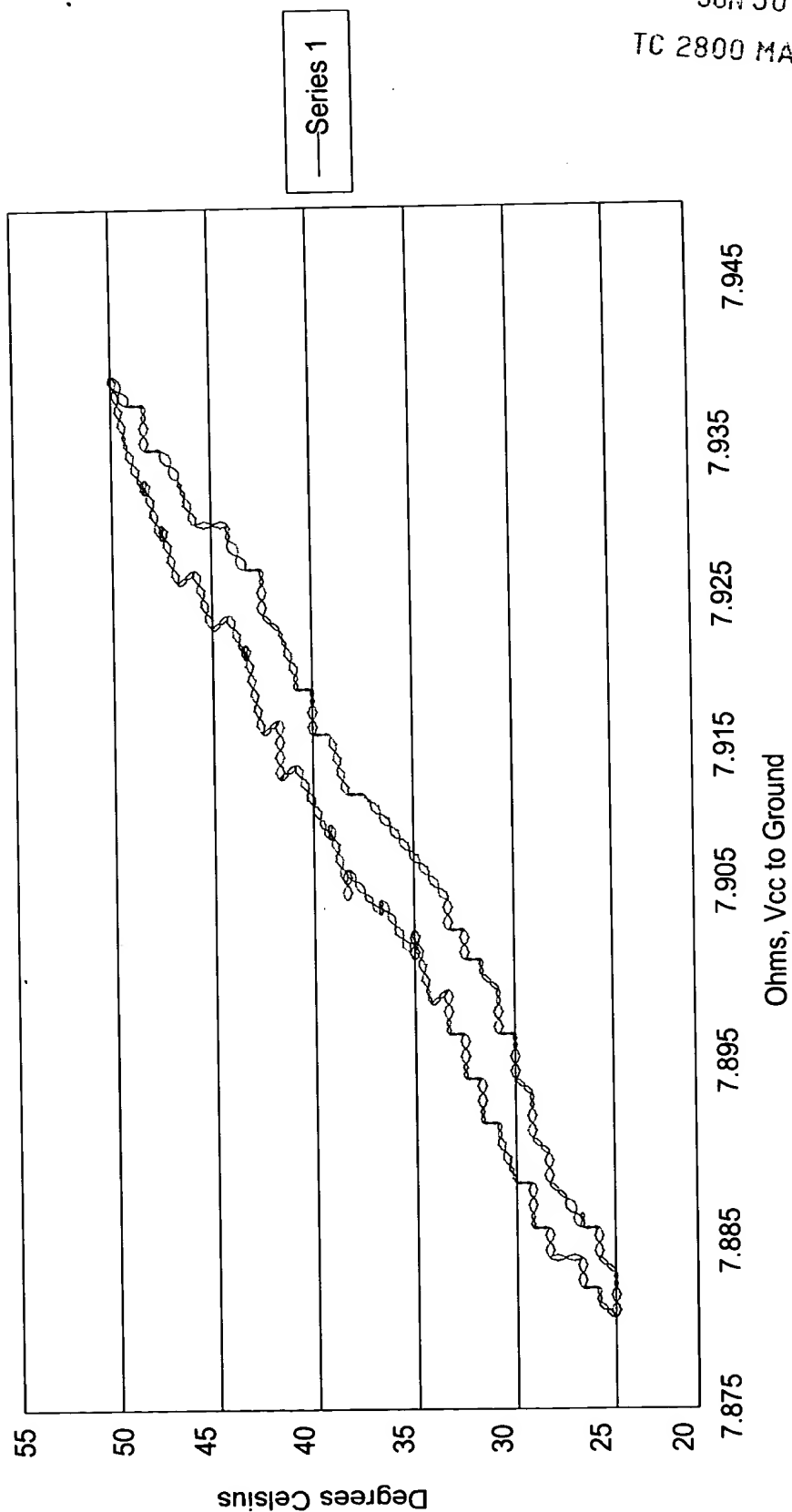


Fig. 5



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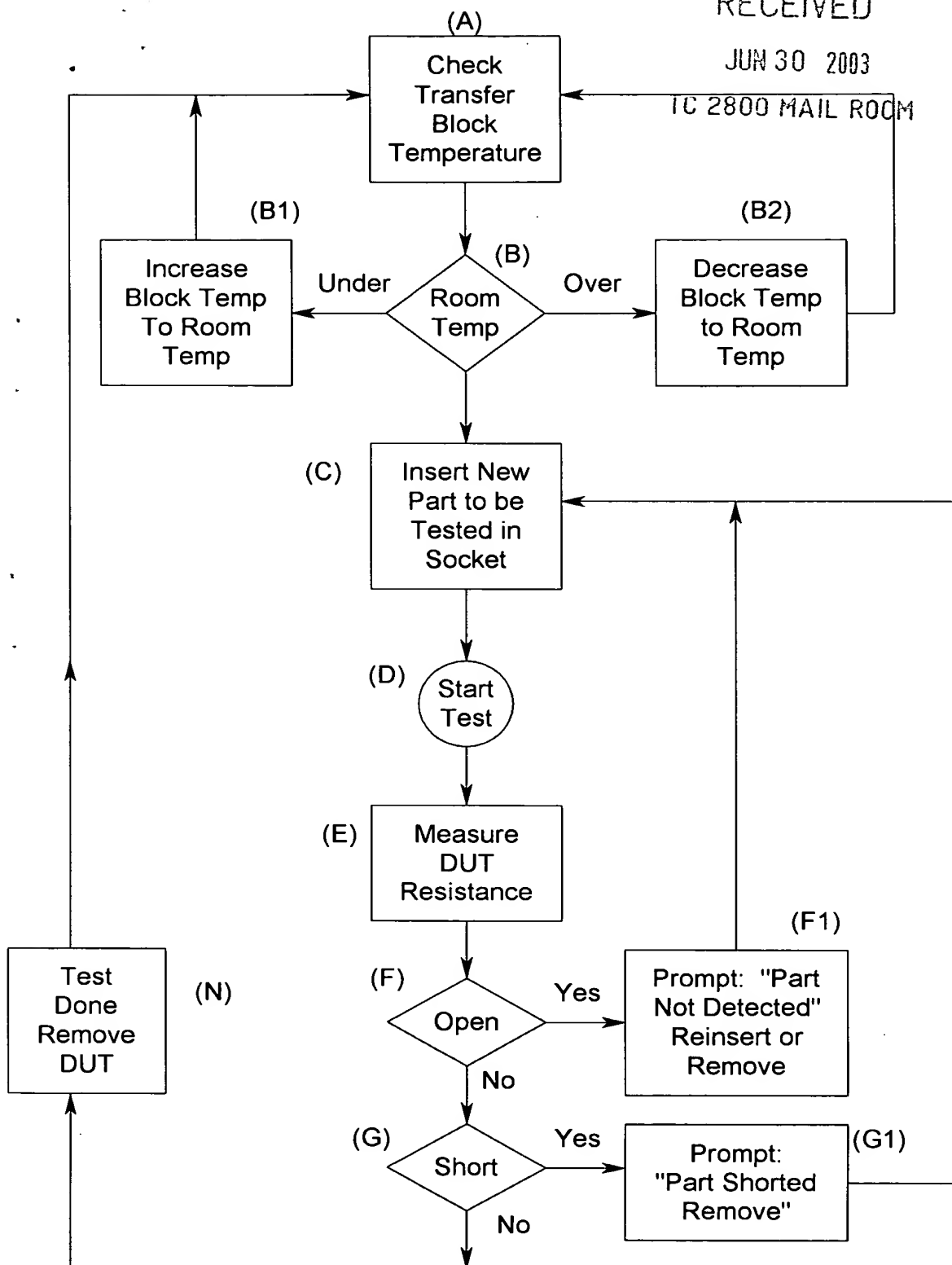


Fig. 6A



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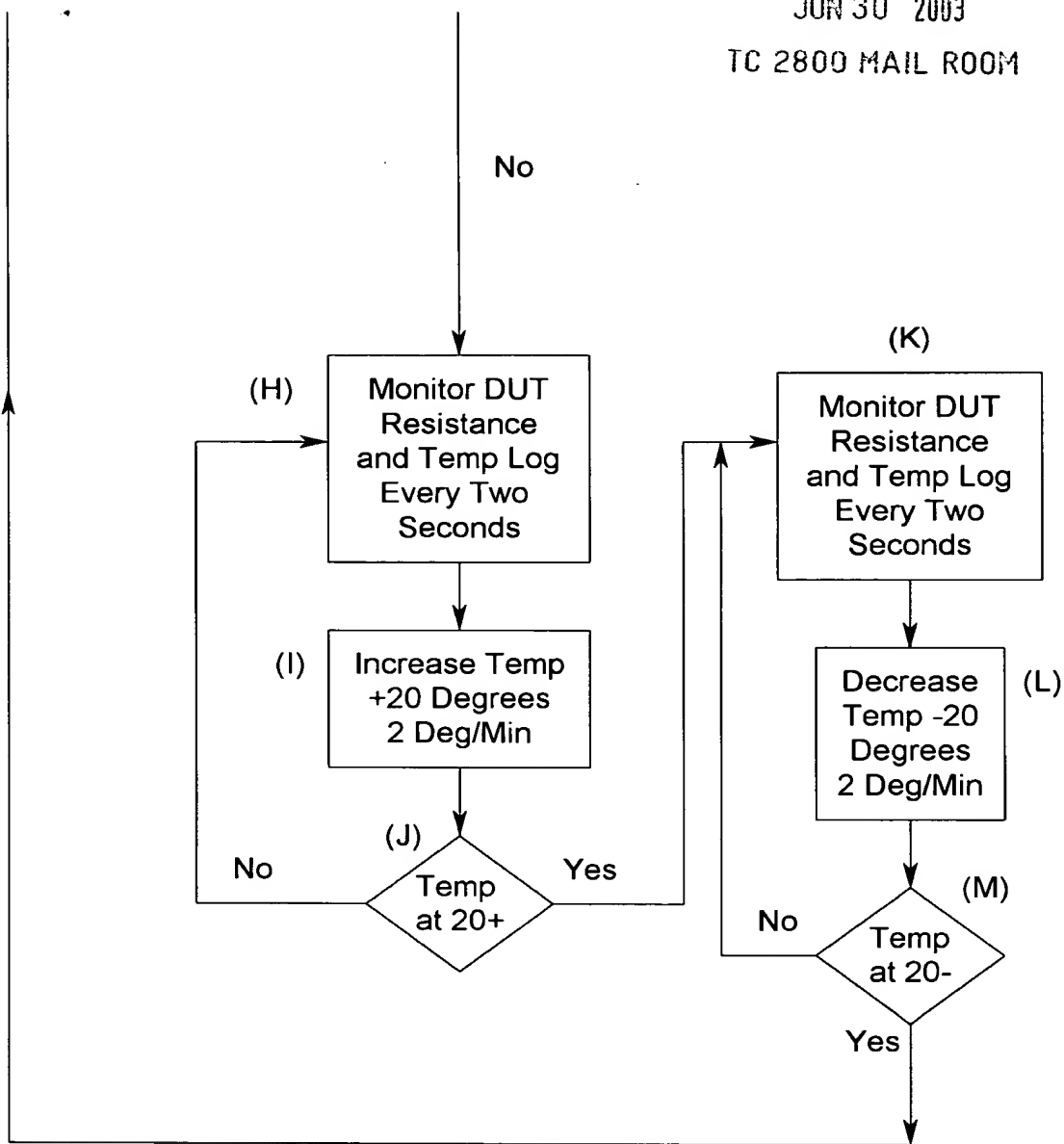


Fig. 6B